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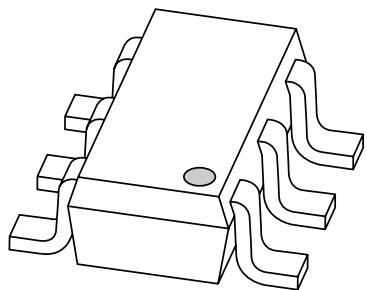
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# DATA SHEET



## **PMEM4010PD** PNP transistor/Schottky diode module

Product data sheet

2002 Oct 28

**PNP transistor/Schottky diode module****PMEM4010PD****FEATURES**

- 600 mW total power dissipation
- High current capability
- Reduces required PCB area
- Reduced pick and place costs
- Small plastic SMD package.

**Transistor:**

- Low collector-emitter saturation voltage.

**Diode:**

- Ultra high-speed switching
- Very low forward voltage
- Guard ring protected.

**APPLICATIONS**

- DC/DC convertors
- Inductive load drivers
- General purpose load drivers
- Reverse polarity protection circuits.

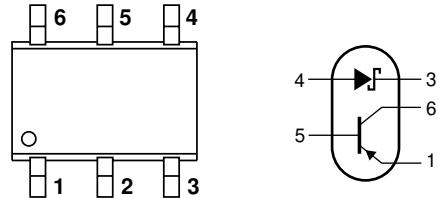
**DESCRIPTION**

Combination of a PNP transistor with low  $V_{CEsat}$  and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.

NPN complement: PMEM4010ND.

**PINNING**

PIN	DESCRIPTION
1	emitter
2	not connected
3	cathode
4	anode
5	base
6	collector



MGU868

Marking code: B2.

Fig.1 Simplified outline (SOT457) and symbol.

## PNP transistor/Schottky diode module

PMEM4010PD

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
<b>NPN transistor</b>					
$V_{CBO}$	collector-base voltage	open emitter	–	–40	V
$V_{CEO}$	collector-emitter voltage	open base	–	–40	V
$V_{EBO}$	emitter-base voltage	open collector	–	–5	V
$I_C$	collector current (DC)		–	–1	A
$I_{CM}$	peak collector current		–	–2	A
$I_{BM}$	peak base current		–	–1	A
$T_j$	junction temperature		–	150	°C
<b>Schottky barrier diode</b>					
$V_R$	continuous reverse voltage		–	20	V
$I_F$	continuous forward current		–	1	A
$I_{FSM}$	non repetitive peak forward current	$t = 8.3 \text{ ms half sinewave};$ JEDEC method	–	5	A
$T_j$	junction temperature		–	125	°C
<b>Combined device</b>					
$P_{tot}$	total power dissipation	$T_{amb} \leq 25 \text{ °C}; \text{ note 1}$	–	600	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_{amb}$	operating ambient temperature		–65	+125	°C

**Note**

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th \text{ j-a}}$	thermal resistance from junction to ambient	in free air; note 1	208	K/W

**Note**

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.

## PNP transistor/Schottky diode module

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## CHARACTERISTICS

 $T_{amb} = 25^\circ C$  unless otherwise specified.

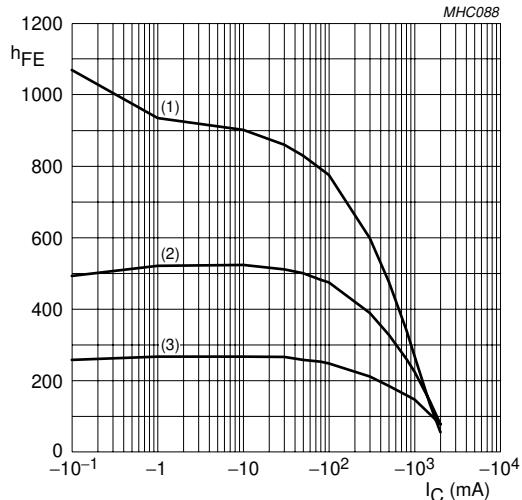
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>NPN transistor</b>						
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -40 V; I_E = 0$	—	—	-100	nA
		$V_{CB} = -40 V; I_E = 0; T_{amb} = 150^\circ C$	—	—	-50	$\mu A$
$I_{CEO}$	collector-emitter cut-off current	$V_{CE} = -30 V; I_B = 0$	—	—	-100	nA
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5 V; I_C = 0$	—	—	-100	nA
$h_{FE}$	DC current gain	$V_{CE} = -5 V; I_C = -1 mA$	300	—	—	
		$V_{CE} = -5 V; I_C = -100 mA$	300	—	800	
		$V_{CE} = -5 V; I_C = -500 mA$	250	—	—	
		$V_{CE} = -5 V; I_C = -1 A$	160	—	—	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -100 mA; I_B = -1 mA$	—	—	-140	mV
		$I_C = -500 mA; I_B = -50 mA$	—	—	-170	mV
		$I_C = -1 A; I_B = -100 mA$	—	—	-310	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -1 A; I_B = -50 mA$	—	—	-1.1	V
$R_{CEsat}$	equivalent on-resistance	$I_C = -500 mA; I_B = -50 mA; \text{note 1}$	—	300	<340	$m\Omega$
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -5 V; I_C = -1 A$	—	—	-1	V
$f_T$	transition frequency	$I_C = -50 mA; V_{CE} = -10 V; f = 100 MHz$	150	—	—	MHz
<b>Schottky barrier diode</b>						
$V_F$	continuous forward voltage	$I_F = 10 mA; \text{note 1}$	—	240	270	mV
		$I_F = 100 mA; \text{note 1}$	—	300	350	mV
		$I_F = 1000 mA; \text{see Fig.7; note 1}$	—	480	550	mV
$I_R$	reverse current	$V_R = 5 V; \text{note 1}$	—	5	10	$\mu A$
		$V_R = 8 V; \text{note 1}$	—	7	20	$\mu A$
		$V_R = 15 V; \text{see Fig.8; note 1}$	—	10	50	$\mu A$
$C_d$	diode capacitance	$V_R = 5 V; f = 1 MHz; \text{see Fig.9}$	—	19	25	pF

## Note

1. Pulse test:  $t_p \leq 300 \mu s; \delta \leq 0.02$ .

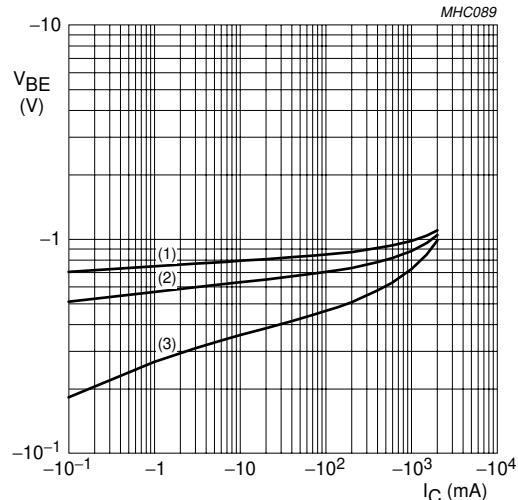
## PNP transistor/Schottky diode module

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**PNP transistor;  $V_{CE} = -5$  V.**

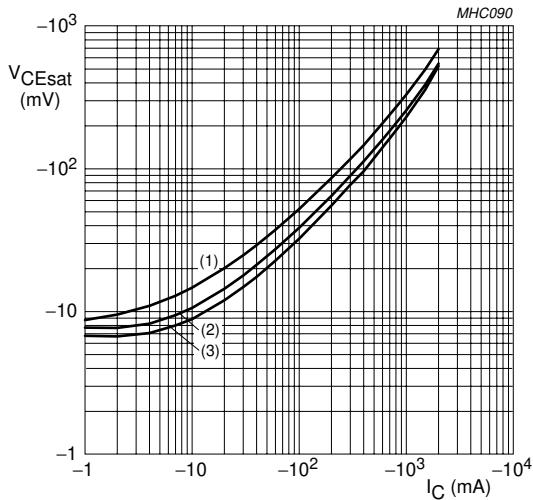
- (1)  $T_{amb} = 150$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

Fig.2 DC current gain as a function of collector current; typical values.

**PNP transistor;  $V_{CE} = -5$  V.**

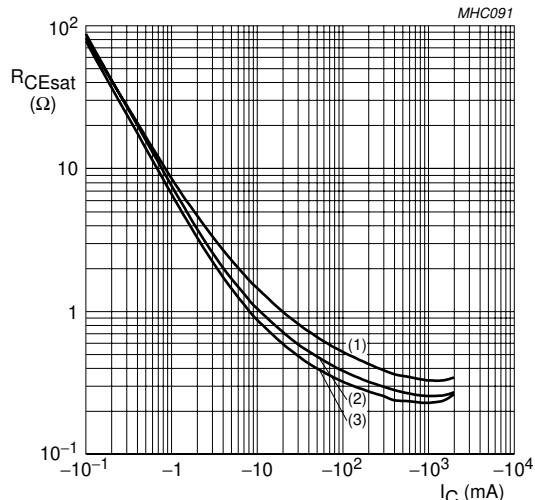
- (1)  $T_{amb} = -55$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = 150$  °C.

Fig.3 Base-emitter voltage as a function of collector current; typical values.

**PNP transistor;  $I_C/I_B = 10$ .**

- (1)  $T_{amb} = 150$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.

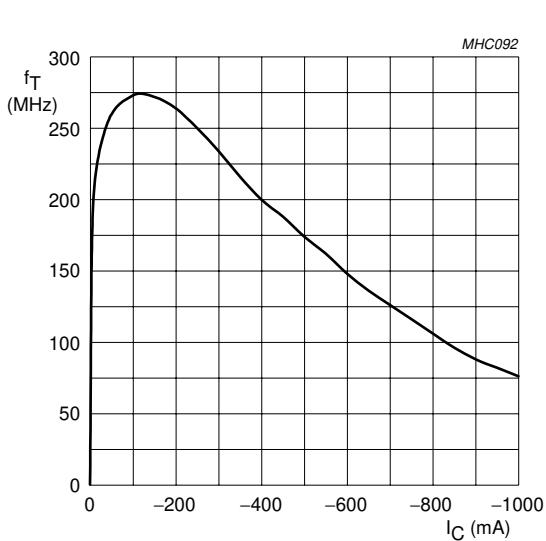
**PNP transistor;  $I_C/I_B = 10$ .**

- (1)  $T_{amb} = 150$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

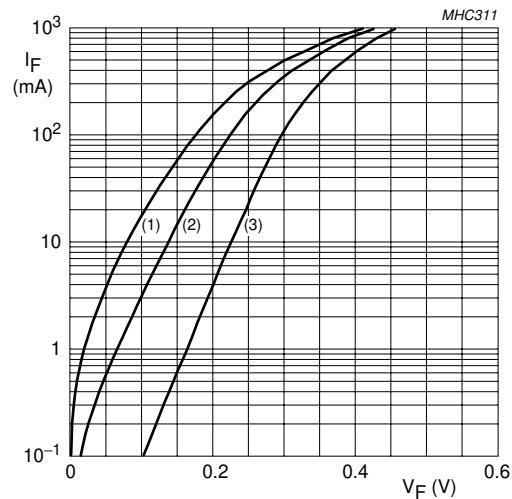
## PNP transistor/Schottky diode module

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**PNP transistor;**  $V_{CE} = -10$  V.

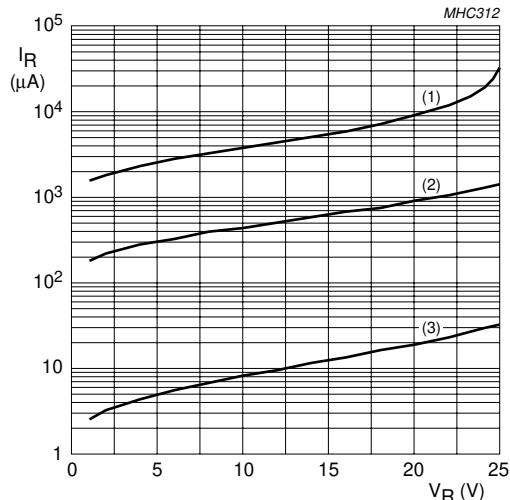
Fig.6 Transition frequency as a function of collector current.



**Schottky barrier diode.**

- (1)  $T_{amb} = 125$  °C.
- (2)  $T_{amb} = 85$  °C.
- (3)  $T_{amb} = 25$  °C.

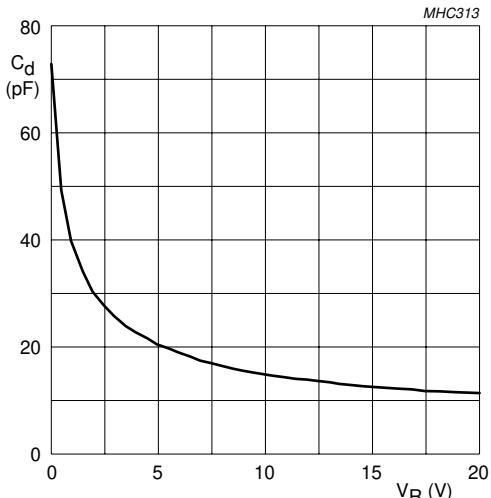
Fig.7 Forward current as a function of forward voltage; typical values.



**Schottky barrier diode.**

- (1)  $T_{amb} = 125$  °C.
- (2)  $T_{amb} = 85$  °C.
- (3)  $T_{amb} = 25$  °C.

Fig.8 Reverse current as a function of reverse voltage; typical values.



**Schottky barrier diode;**  $f = 1$  MHz;  $T_{amb} = 25$  °C.

Fig.9 Diode capacitance as a function of reverse voltage; typical values.

## PNP transistor/Schottky diode module

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## APPLICATION INFORMATION

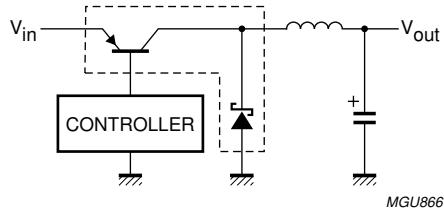


Fig.10 DC/DC convertor.

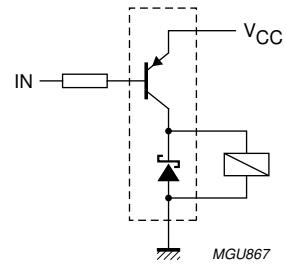


Fig.11 Inductive load driver (relays, motors, buzzers) with free-wheeling diode.

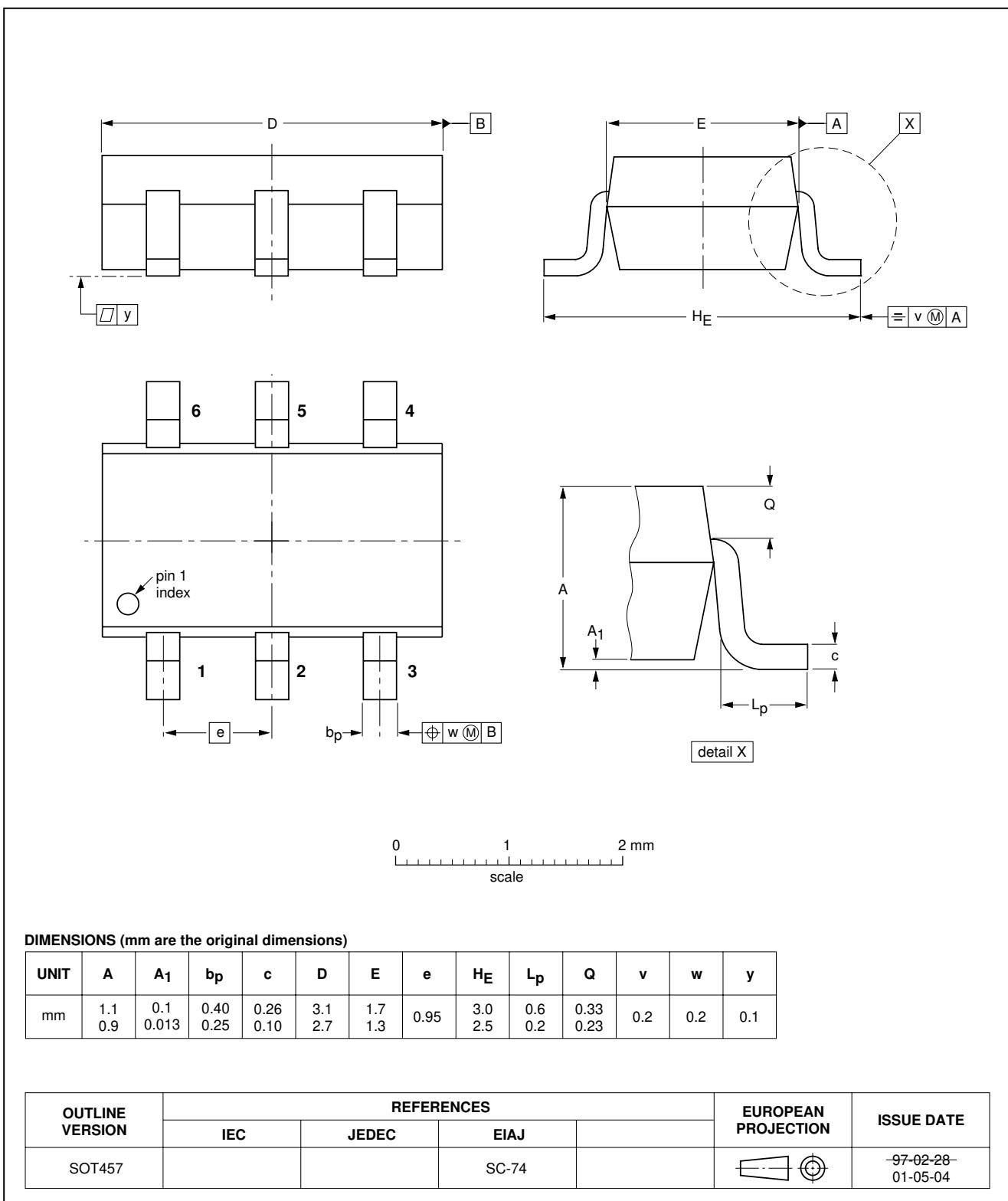
## PNP transistor/Schottky diode module

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## PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



## DIMENSIONS (mm are the original dimensions)

UNIT	A	$A_1$	$b_p$	c	D	E	e	$H_E$	$L_p$	Q	v	w	y
mm	1.1 0.9	0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ	SC-74		
SOT457						97-02-28 01-05-04

## PNP transistor/Schottky diode module

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## DATA SHEET STATUS

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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## **Contact information**

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